

Mars ZX3 SoC Module

Reference Design for Mars PM3 Base Board User Manual

Purpose

The purpose of this document is to present to the user the overall view of the Mars ZX3 SoC module reference design and to provide the user with a step-by-step guide to the complete Xilinx SoC design flow used for the Mars ZX3 SoC module.

Summary

This document first gives an overview of the Mars ZX3 SoC module reference design and then guides through the complete Xilinx SoC design flow for the Mars ZX3 SoC module in the getting started section. In addition, the internals and the boot options of the Mars ZX3 SoC module reference design are described.

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1 Overview

1.1 Introduction

The Mars ZX3 SoC module reference design demonstrates a system using the Mars ZX3 SoC module in combination with the Mars PM3 base board. It presents the basic configuration of the device and features some example applications.

A troubleshooting section is included at the end of the document, to help the user solve potential issues related to board connectivity and/or system functionality.

An introduction to the Xilinx® tools is provided by the documents below:

- Zyng®7000 All Programmable SoC Embedded Design Tutorial [1]
- Vivado Design Suite User Guide, Embedded Processor Hardware Design [2]
- Vivado Design Suite Tutorial, Embedded Processor Hardware Design [3]

More information on the Mars ZX3 SoC module and the Mars PM3 base board can be retrieved from their respective user manuals [5] [6].

1.2 Directory Structure

The Mars ZX3 SoC module reference design is delivered as a ZIP archive file with the following directory structure and contents:

- binaries Pre-compiled binaries directory
- scripts Scripts directory required for Vivado project creation
- SdkExport Pre-generated hardware description files required for SDK applications
- software Software projects directory
- src Xilinx pinout and timing constraints and VHDL source code directory
- Mars_ZX3_Reference_Design_for_Mars_PM3_User_Manual.pdf User manual (this document)

1.3 Prerequisites

- IT
- A computer with a microSD card slot (optional¹) running Windows 7 64-bit
- Software
 - Xilinx Vivado 2015.2 WebPack, Evaluation, Design or System Edition
 - Xilinx Software Development Kit (SDK) 2015.2
 - Enclustra Module Configuration Tool (MCT) [7] (optional²)
 - PuTTY (optional³)
- Hardware
 - An Enclustra Mars ZX3 SoC module
 - An Enclustra Mars PM3 base board
- Accessories
 - A standard micro USB cable⁴
 - A JTAG PM3 breakout board or a Xilinx JTAG breakout cable
 - A Xilinx JTAG programmer (e.g. Platform Cable USB) download cable
 - A microSD card (optional¹)

¹Only required for SD card boot mode

²May be used for flash programming, for SoC device configuration or for Cypress FX3 configuration.

³Required for running the Ethernet lwIP example

⁴An extra USB type B cable is required for running the USB storage emulation example.

2 Reference Design Description

2.1 Block Diagram

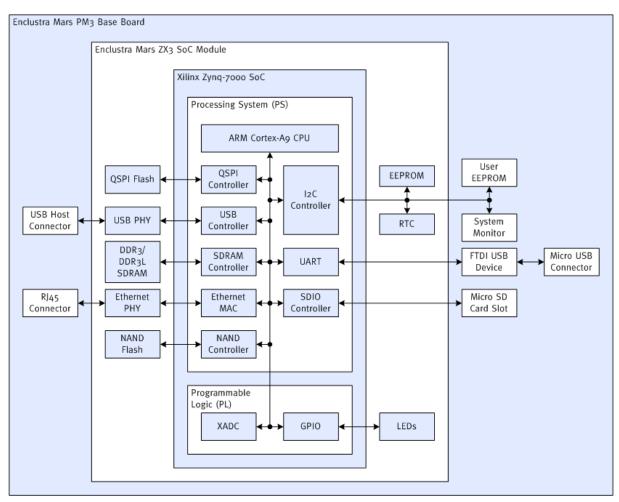


Figure 1: Hardware Block Diagram

2.2 Processing System (PS)

2.2.1 Clocks

The PS input clock frequency is configured to 33.33 MHz, while the CPU clock frequency is configured to 666.66 MHz. The CPU clock frequency multiplier can be modified in the Zynq system. A 50 MHz clock is exported from PS to the PL.

2.2.2 DDR3/DDR3L SDRAM

The DDR3/DDR3L SDRAM memory controller runs at 400 MHz (800 Mbit/sec) at a voltage of 1.35 V by default. These parameters can be modified in the Zynq system. For a voltage of 1.5 V, beside the changes in the PS, it is necessary to change the top level assignment to DDR3_VSEL signal from logic low to high impedance.

The DDR settings in the Zynq system must be configured according to the Mars ZX3 SoC Module User Manual [5].

2.2.3 SD Card

The SD card is configured in the PS to the MIO 40..45 pins. This enables SD card access, as well as booting from the SD card.

To allow the Mars ZX3 SoC module to boot from the SD card, the hardware configuration on the Mars PM3 base board must be done according to Section 4.2.2.

Please note that the SD pins are shared between the PS and the PL.

Warning!

Because the MIOs 40..45 are connected to FPGA pins Y18, AA18, AA17, AB17, U17, V17 in parallel, make sure the FPGA pins are in high impedance state before driving the PS SD pins and vice versa.

In order to be able to access and write to the SD card from Linux, it is recommended to enable the Write Protect (WP) and Card Detect (CD) pins in the PS, map them to EMIO pins and tie them off to high, respectively low state. An example is available in the reference design sources.

2.2.4 I2C

The I2C controller I2C0 is configured to the EMIO pins. Table 1 lists the connected devices on the Mars ZX3 SoC module.

Device	Address (7-bit)	Vendor	Part Type
Real-time clock	0x6F	Intersil	ISL12020MIRZ
RTC user SRAM	0x57	Intersil	ISL12020MIRZ
Secure EEPROM	0x5C	Maxim	DS28CN01
I2C GPIO expander	0x21	Semtech	SX1505I087TRT
User EEPROM	0x54	Microchip	24AA128T-I/MNY
System monitor	0x2F	Texas Instruments	LM96080CIMT/NOPB

Table 1: I2C Devices

The device vendors or addresses of the I2C devices may change in future revisions of Mars ZX3 SoC module or Mars PM3 base board.

For detailed information on the I2C devices, please refer to the corresponding user manuals [5] [6].

2.2.5 Quad SPI Flash Controller

The quad SPI flash controller is connected to MIO 1..6 and 8 pins in Single Slave Select mode. MIO 2..6 pins are shared between NAND flash and QSPI flash on the Mars ZX3 SoC module. Please refer to the Mars ZX3 SoC Module User Manual [5] for details about flash programming and usage.

To allow the Mars ZX3 SoC module to boot from the QSPI flash, the hardware configuration on the Mars PM3 base board must be done according to Section 4.1.2.

2.2.6 **UART**

The UART0 is connected to the EMIO pins in PS and to the FTDI USB device controller on the Mars PM3 base board. The UART is configured as shown in Table 2.

Parameter	Value
Baud rate	115'200
Data	8 bit
Parity	None
Stop	1 bit
Flow control	None

Table 2: UART Configuration

2.2.7 Ethernet

The Ethernet MAC ENETO is connected to MIO 16..27 and 52..53 in the PS and to a Micrel KSZ9031 Ethernet PHY on the Mars ZX3 SoC module using an RGMII interface. The PHY can be configured via the MDIO management interface on PHY address 3.

Please note that the RGMII delays in the Ethernet PHY need to be configured before the Ethernet interface can be used. In the reference design this is done in the First Stage Boot Loader (FSBL) and in the Ethernet lwIP example.

Note that the Ethernet pins are shared between the PS and the PL.

Warning!

Because the MIOs 16..27 and 52..53 are connected to FPGA pins V10, V9, V8, W8, W11, W10, U11, U10, AA12, AB12, Y11, Y9, Y8, U6 in parallel, make sure the FPGA pins are in high impedance state before driving the PS ENETO pins and vice versa.

2.2.8 USB

The USB controller USB0 on MIO 28..39 pins is connected to a USB3320C USB 2.0 PHY. This interface can be configured for USB host, USB device and USB On-The-Go (OTG) operations.

Depending on the required USB mode, the DIP switches on the Mars PM3 base board must be configured correctly. Please refer to the Mars PM3 Base Board User Manual [6] for details.

2.2.9 **GPIOs**

The unused MIO pins from the PS are available as GPIOs. They are mapped to MIO pins 0, 7, 9..15, and 46..51 in the PS. The function of the general purpose pins on the Mars ZX3 SoC module is described in Table 3.

The shared pins can be used either in the PL or in the PS.

GPIO	Signal	Function
MIO 15	MDIO_SEL_LED1#	MDIO select, see Mars ZX3 SoC Module User Manual [5] for details
MIO 46	GPIO 46	GPIO, shared with FPGA pin U15
MIO 47	GPIO 47	GPIO, shared with FPGA pin U16
MIO 48	GPIO 48	GPIO, shared with FPGA pin W16
MIO 49	GPIO 49	GPIO, shared with FPGA pin Y16
MIO 50	GPIO 50	GPIO, shared with FPGA pin W17
MIO 51	GPIO 51	GPIO, shared with FPGA pin W18

Table 3: PS GPIO Configuration

Warning!

Because the MIOs 46..51 are connected to FPGA pins U15, U16, W16, Y16, W17, W18 in parallel, make sure the FPGA pins are in high impedance state before driving the PS GPIO pins and vice versa.

Warning!

Make sure that all unused FPGA pins are in high impedance state in the top-level, as they may be driven by other devices, or by pull-up/pull-down resistors. An example is given in the VHDL source code and constraints provided in the ZIP archive along with this document.

2.3 Programmable Logic (PL)

2.3.1 **GPIOs**

A Xilinx GPIO controller in the PL is connected to the PS via an AXI bus. The PL GPIOs are connected to LEDs in the top level, as described in Table 4.

The FPGA firmware contains a 24-bit counter freely running at 50 MHz. The MSB of this counter is used to blink LED3# on FPGA pin AB15 with a frequency of approximately 3 Hz.

The least three significant bits of the GPIO bus from the PL are connected to the LED0#, LED1# and LED2# outputs.

FPGA Pin	Signal	Function
H18	LED0#	GPIO 0, controlled by the PL GPIO controller
AA14	LED1#	GPIO 1, controlled by the PL GPIO controller
AA13	LED2#	GPIO 2, controlled by the PL GPIO controller
AB15	LED3#	Blinking LED counter MSB

Table 4: FPGA Firmware I/O Configuration

2.3.2 XADC

A Xilinx XADC IP core instance is connected to the PS via an AXI bus, in order to monitor the temperature of the device. The temperature threshold for this module is configured to the industrial applications temperature, 85° Celsius.

The constraints provided in the reference design enable FPGA bitstream power-down, when the temperature increases above the threshold. In this case, the PL will be reset, while the ARM processor will still be running.

Depending on the user application, the Mars ZX3 SoC module may consume more power than can be dissipated through conduction in stationary air; always make sure the SoC is adequately cooled by installing a heat sink and/or providing air flow. Temperature control and monitoring is very important in a complex design.

Information that may assist in selecting the correct heat sink for the Mars ZX3 SoC module can be found in the Enclustra Modules Heat Sink Application Note [8].

3 Getting Started

This section describes the steps required to configure the Mars ZX3 SoC module and Mars PM3 base board in order to run the example applications. The section includes information on how to:

- Mount the module and configure the base board
- Generate the FPGA bitstream
- Prepare the software workspace
- Run the software applications

The example applications, including the expected results of running the software, are described in detail in Section 3.7.

3.1 Essential Information

Warning!

Never mount or remove the Mars ZX3 SoC module to or from the Mars PM3 base board while the Mars PM3 base board is powered. Always remove or turn off the power supply before mounting or removing the Mars ZX3 SoC module.

Warning!

Depending on the user application, the Mars ZX3 SoC module may consume more power than can be dissipated through conduction in stationary air; always make sure the SoC is adequately cooled by installing a heat sink and/or providing air flow.

Warning!

Please read carefully the Mars ZX3 SoC module and Mars PM3 base board user manuals before proceeding.

Note that when Enclustra MCT [7] is used for SoC configuration or flash programming, all other tools that may be connected to the FTDI device (e.g. Vivado Hardware Manager, SDK, UART terminal) must be closed.

3.2 Hardware Setup

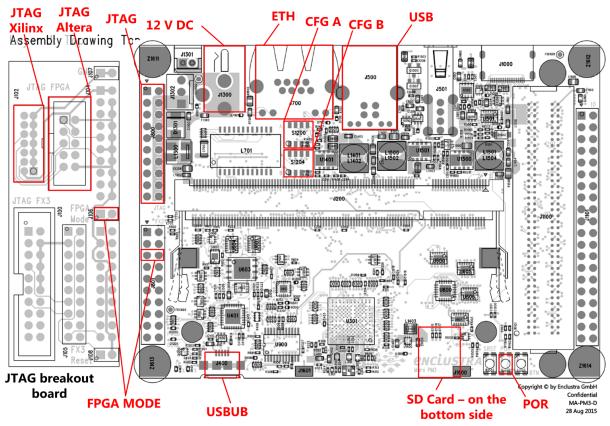


Figure 2: Mars PM3 Base Board Assembly Drawing (Top View)

Step	Description
1	Set the configuration DIP switches on the Mars PM3 base board as follows (see labels CFG A and CFG B in Figure 2):
	 CFG A = [1: ON, 2: OFF, 3: OFF, 4: OFF] CFG B = [1: ON, 2: OFF, 3: OFF, 4: OFF]
	For Mars PM3 base board revision 4 or older, set the configuration DIP switches as follows:
	• CFG = [1: OFF, 2: OFF, 3: OFF, 4: OFF]
2	Make sure the SD card slot of the Mars PM3 base board is empty (see label SD Card in Figure 2).
3	Mount the Mars ZX3 SoC module to the Mars PM3 base board.
4	Connect the micro USB cable between your computer and the Mars PM3 base board. Use the micro USB port labeled USBUB in Figure 2.

Continued on next page...

Step	Description
5	Connect the Xilinx Platform USB download cable to the JTAG connector of the JTAG PM3 breakout board (see label JTAG Xilinx in Figure 2). If a Xilinx JTAG breakout cable is used, use the pins labeled JTAG in Figure 2. Please refer to the Mars PM3 Base Board User Manual [6] for JTAG pins mapping.
6	Connect the 12 V DC power supply plug to the power connector of the Mars PM3 base board (see label 12 V DC in Figure 2).
7	Open a terminal program on your computer (e.g. Tera Term) and open a serial port connection using the COM port labeled with the lower number from the two newly detected ports. For issues related to COM ports detection, refer to Section 5.4.
	Configure the UART parameters according to Section 2.2.6.

Table 5: Hardware Setup Step-By-Step Guide

3.3 FPGA Bitstream Generation

For a fast test of the provided software applications, the pre-generated bitstream included in the binaries directory may alternatively be used, therefore the steps described in this section may be skipped.

The <base_dir>\binaries directory includes bitstream files for any SoC device that may be equipped on the module.

Step	Description
1	Edit the fpga_part variable in scripts\settings.tcl file, according to your SoC device. This file includes module name and board information required for the project creation script.
	All settings, except for fpga_part should be left on default. The list of options for fpga_part are given in the comments within the Tcl file.
	Save the file after editing.
2	Start Xilinx Vivado 2015.2 and create the Mars ZX3 SoC module reference design project:
	1. Click on the Tcl console at the bottom of the page and type:
	(a) cd <base_dir> (<base_dir> is the directory in which you extracted the archive contents). Note that you must use / for hierarchy separator, instead of \.</base_dir></base_dir>(b) source scripts/create_project.tcl
	2. Wait for completion
3	Run Synthesis, Implementation & Bitstream Generation in Vivado 2015.2:
	Click on Generate Bitstream from the Flow Navigator bar - this will start automatically the entire implementation process
	2. Wait for completion $ o$ select View Reports $ o$ OK

Continued on next page...

Step	Description
4	Export the hardware system information (required for the SDK projects):
	 File → Export → Export Hardware Enable Include bitstream checkbox If you want to save the .hdf file to another path than the default location: Click on Choose Location → Select Hit OK

Table 6: FPGA Bitstream Generation Step-By-Step Guide

3.4 SDK Workspace Preparation

This section describes how to create and import the software applications. The steps are generic, and apply to all software examples provided in the release archive, along with this document.

The <base_dir>\SdkExport directory includes pre-generated hardware description files for any SoC device that may be equipped on the module.

Step	Description
1	Start Xilinx SDK 2015.2
	1. Select any workspace (e.g. <base_dir>\workspace)</base_dir>
2	Create a new board support package (BSP)
	1. File \to New \to Board Support Package \to Specify 2. In the New Hardware Project window:
	 (a) For Project Name type hw_platform_0 (b) For Target Hardware Specification select the .hdf file you exported from Vivado, as described in Section 3.3. The default location used by Vivado is <pre></pre>
	3. In the New Board Support Package Project window:
	(a) For Project Name type standalone_bsp_0(b) For Hardware Platform select hw_platform_0(c) For CPU select ps7_cortexa9_0(d) Hit Finish
	4. In the Board Support Package Settings window (see Figure 3):
	(a) Enable the checkboxes corresponding to the drivers and libraries required in the BSP: lwip141, xilffs, xilmfs, xilrsa(b) Hit OK

Continued on next page...

Step	Description
3	Create new First Stage Boot Loader application
	 File → New → Application Project In the Application Project window: (a) For Project Name type FSBL (b) For Board Support Package select Use existing, and select standalone_bsp_0 (c) Leave the other settings on default values (d) Hit Next In the Templates window: (a) Select Zynq FSBL (b) Hit Finish Using Windows Explorer, copy the files provided in base_dir>\software\FSBL\src directory (and replace the fsbl_hooks.c file). This step is required as per explanation in Section
	3.7.8.
4	 Import the example projects into the workspace File → Import Select General → Existing Projects into Workspace and hit Next For Select root directory choose <base_dir>\software and hit OK</base_dir> Enable checkbox Copy projects into workspace Hit Finish
5	Build all projects 1. Hit Ctrl-B and wait for completion

Table 7: SDK Workspace Preparation Step-By-Step Guide

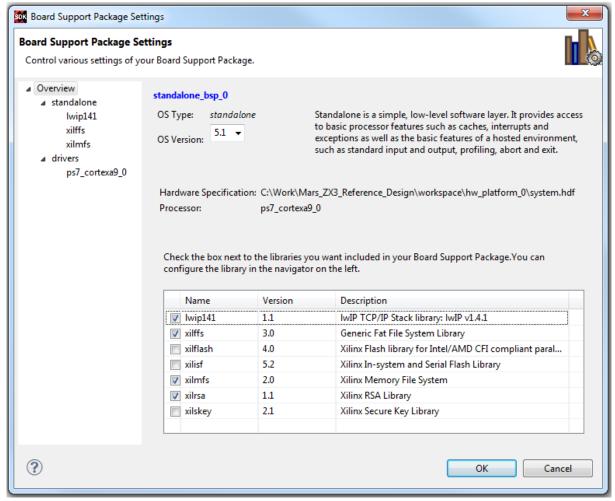


Figure 3: Board Support Package Settings

3.5 FPGA Programming

Step	Description
1	Open Xilinx SDK 2015.2:
	 Click on Xilinx Tools → Program FPGA For Hardware Platform select hw_platform_0 For Bitstream field hit Search → select system_top.bit Hit Program
	The configuration is shown in Figure 4.
	For issues related to JTAG connection, refer to Section 5.3.
2	After the FPGA is successfully configured, the DONE LED should be lit.
	For Mars PM3 base board revision 4 or older, the RDY LED should be lit.

Table 8: FPGA Programming Step-By-Step Guide

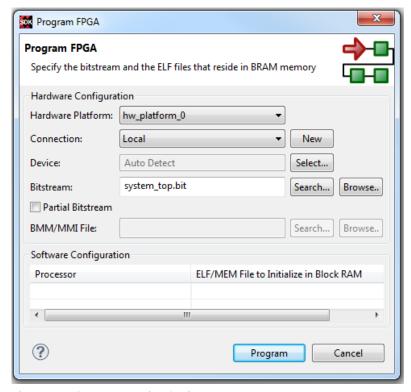


Figure 4: FPGA Programming Settings

3.6 Running Software Applications

This section describes how to run software applications on the Mars ZX3 SoC module. The steps are generic, and apply to all software examples provided in the release archive, along with this document.

In order to execute the applications, the hardware needs to be configured as described in Section 3.2.

Note that the FPGA must be programmed before running the software applications. Refer to Section 3.5 for details on FPGA programming.

Step	Description
1	Create a run configuration for the application in SDK 2015.2:
	 Run → Run Configurations Right-click Xilinx C/C++ application (GDB) and hit New or double-click on Xilinx C/C++ application (GDB) Enter a run configuration name in the Name field (e.g. hello_world) Target Setup tab (see Figure 5): (a) For Hardware Platform select hw_platform_0 (b) For CPU select ps7_cortexa9_0 (c) In the Bitstream file field, hit Search (d) Select system_top.bit and hit OK (e) In the Initialization file field, hit Search (f) Select ps7_init.tcl and hit OK (g) Enable checkboxes Run p7_init and Run ps7_post_config Application tab: (a) In the Project Name field click browse and select an application (e.g. MemoryTest) (b) In the Application field click search and select an .elf file (c) Hit Apply
2*	Optional - for the lwIP example application, the following extra steps are required:
	 Select the Application tab (see Figure 6) In the Data Files to download before launch section: (a) Click Add (b) Select the memory file system image from the lwIP example: <base_dir></base_dir>
3	Start the application by clicking the Run button. In some test setup cases it was observed that the SDK tool was not able to start a second run session without a hardware reset. If required, power off and on the base board and restart the run configuration.

Table 9: Running an Application Step-By-Step Guide

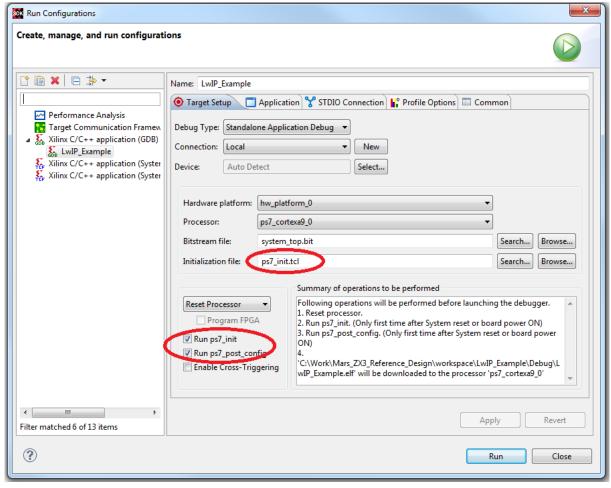


Figure 5: Run Configurations Settings

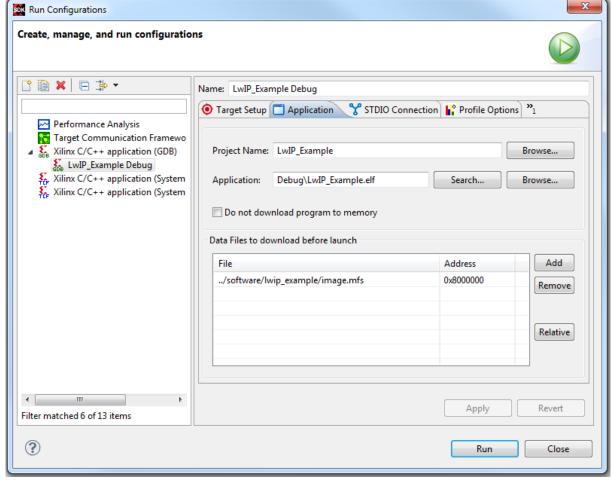


Figure 6: Run Configurations Settings for LwIP Application

3.7 Embedded Software

This section describes the software examples and the expected UART output while running these applications.

3.7.1 General

The Mars ZX3 SoC module reference design comes with a number of example applications, which show how to initialize the peripheral controllers and how to access the external devices. All of them are baremetal applications that are executed in the DDR SDRAM memory, except for the DDR SDRAM memory test, which runs from the on-chip memory.

The applications included are a Hello World example, an I2C test that reads and prints out the module and board configuration, a flash test which checks the QSPI flash memory available on the Mars ZX3 SoC module, a web server implementation example using lwIP networking stack, a USB storage emulation example, and a memory test that checks the DDR SDRAM memory available on the module.

An additional section is included to describe how to create and modify the First Stage Boot Loader (FSBL) application. This application is required during the process of creating a boot image for the module.

As the DDR SDRAM test program is mapped to the on-chip memory, this application cannot be used for building a boot image, because the program will overwrite the boot loader. If needed, the linker script can be changed to use the DDR SDRAM memory for the program execution, but in this case the test is

not conclusive.

The procedure of importing, creating and building the example applications is explained in Sections 3.4, 3.5 and 3.6.

3.7.2 Hello World Application

The Hello World application is a very simple application, which is used to demonstrate all the required steps for getting a bare-metal application running on the Mars ZX3 SoC module.

The Hello World application prints "Hello World x" for twenty times, while x is incremented by one at every iteration. Figure 7 shows the UART output of the Hello World application.

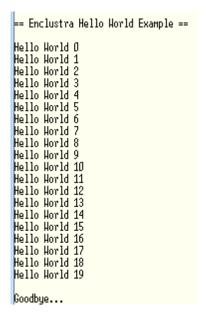


Figure 7: Hello World Application UART Output

3.7.3 I2C Example Application

The I2C example application demonstrates the configuration and use of the I2C controller on the Mars ZX3 SoC module.

The I2C example application reads the module configuration data from the secure EEPROM on the Mars ZX3 SoC module, date and time values from the RTC on the Mars ZX3 SoC module, as well as voltage information from the system monitor present on the Mars PM3 base board.

The module configuration includes: module type, serial number, DDR and flash memory sizes, and first MAC address. The MAC addresses can be used by the user to configure the Ethernet MAC.

Figure 8 shows the UART output of the I2C application.

```
== Enclustra I2C test ==
EEPROH:
    Module type
                                      Mars ZX3
    Revision
    Serial number
                                      110269
                                      20:B0:F7:03:5D:7A
    MAC Address O
                                      Xilinx Zynq-7020 XC7Z020
    SoC type
    SoC speed grade
    Temperature grade
                                      Connercial
    Pouer grade
                                      Normal
   Ethernet port count
   Ethernet speed
Real-time clock equipped
                                      Gigabit
                                      Yes
    USB device port count
    DDR3 RAH size (MB)
                                      512
    SPI flash size (MB)
                                      16
   NAND flash size (MB)
                                      512
Real Time Clock:
    Тіне: 11:22:33
   Date: 22.11.10
    Temperature: 41 Celsius
System Monitor:
VCC_HAIN
VCC_5V
VCC_3V3
VCC_IO
                     Voltage = 12027 HV
                     Voltage = 5064 mV
Voltage = 3298 mV
                     Voltage = 2512 нV
   VCC_1V2
VHON_P41
                     Voltage = 1215 mV
                     Voltage = 1350 mV
    VCC_OUT
                     Voltage = 1770 mV
   End of test ==
```

Figure 8: I2C Example Application UART Output

3.7.4 Memory Test Application

The memory test application performs several tests on the DDR memory present on the Mars ZX3 SoC module. A quick simple test and a detailed full test are executed.

The simple test is run on a larger part of the memory and checks that the sequential incrementing of the address and writing values to the memory works as expected. The full test uses several writing patterns on two different parts of the memory, then reads the values and compares the results. This test is performed on a smaller part of the memory.

Figure 9 shows the UART output of the memory test application. Note that the starting address and the memory size configured for the test depend on the module and on the application settings.

Please note that depending on the DDR memory controller speed and test size, the memory test may take several minutes to complete.

```
= Enclustra Memory Test ==
Testing 4MB @ Address 0xC0100000 (full test)
Loop 1/1:
  Stuck Address
  Random Value
  Compare XOR
                      : ok
  Compare SUB
                      : ok
  Compare MUL
Compare DIV
                      : ok
                      : ok
  Compare OR
  Compare AND
                      : ok
  Sequential Increment: .....ok
  Solid Bits
Block Sequential
                      : .....oķ
  Checkerboard
  Bit Spread
Bit Flip
                      : ....ok
  Halking Ones
Halking Zeroes
                      : .....ok
                      : .....ok
  8-bit Árites
                      : ok
  16-bit Writes
                      : ok
Testing 255MB @ Address 0xC0100000 (quick test)
Loop 1/2:
  Sequential Increment: .....ok
  Sequential Increment: ......ok
= Test finished, no errors occurred ==
```

Figure 9: Memory Test Application - UART Output Example

3.7.5 Flash Test Application

The flash test application is based on the Xilinx SPI controller driver example and performs a write/read-back test of one sector starting at a specific address of the QSPI flash memory. The application initializes the SPI and the interrupt controller and includes read, write and erase functions that show how to access the flash memory on the Mars ZX3 SoC module using the Xilinx SPI controller.

Figure 10 shows the UART output of the flash test application.

```
-- QSPI FLASH Interrupt Example Test --
-- Successfully ran QSPI FLASH Interrupt Example Test --
```

Figure 10: Flash Test Application UART Output

3.7.6 Ethernet LwIP Application

The Ethernet lwIP application represents a basic example of running a web server on the Mars ZX3 SoC module using the open-source TCP/IP networking stack lightweight IP (lwIP).

The example is based on the Xilinx lwIP example (see Xilinx Application Note [4]), modified for compatibility with the Ethernet PHY used on the Mars ZX3 SoC module.

In order to do this change, one of the files generated automatically in the board support package (xemacpsif physpeed.c) has been modified and copied to the project sources.

Before launching the Ethernet lwIP application, the network adapter of the computer needs to be configured as described below.

It is recommended to have a second network adapter for local connections and keep the current network setup on the default adapter, in order to avoid reconfiguring the connection parameters.

Computer Setup

Step	Description
1	Connect a network cable (RJ45) between your computer and the Mars PM3 base board. Use the connector marked with label ETH in Figure 2.
2	Open Control Panel $ o$ Network and Internet $ o$ Network and Sharing Center
3	Click on the Local Area Connection $ o$ Properties (see Figure 11)
	1. Disable all connections except Internet Protocol Version 4 (TCP/IPv4) 2. Click on Internet Protocol Version 4 (TCP/IPv4) \rightarrow Properties
	(a) Set the IP address to 192.168.1.1 (b) Set the subnet mask to 255.255.255.0 (c) Hit OK

Table 10: Computer Network Setup Step-By-Step Guide

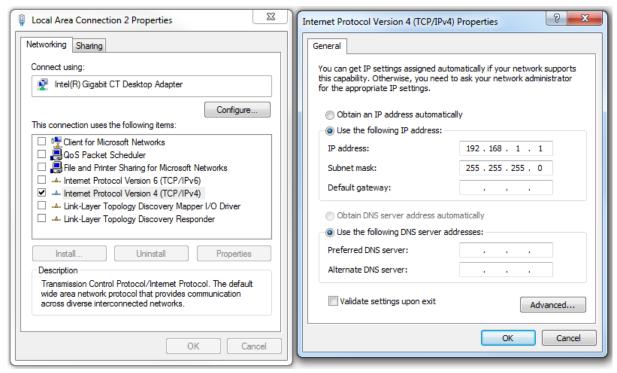


Figure 11: Network Adapter Configuration for LwIP Application

Please note that a memory file system (MFS) image must be downloaded to the RAM for the application to run. Section 3.6 describes the required steps to run the lwIP Ethernet application.

After having the computer setup, as well as the run configurations done, two tests can be performed using the lwIP application.

The testing procedure and the expected UART output are further presented.

Testing the LwIP Web Server

Step	Description
1	Open a web browser
2	Type http://192.168.1.10/ in the address bar
	A basic web page indicating the current state of the LEDs on the Mars ZX3 SoC module will be loaded in the browser.
	The user can toggle the LEDs using a button in the web page.
	Figure 12 illustrates the lwIP application web page.
3	Click the Toggle LEDs button, in order to change the state of the LEDs.

Table 11: Testing the LwIP Web Server Step-By-Step Guide

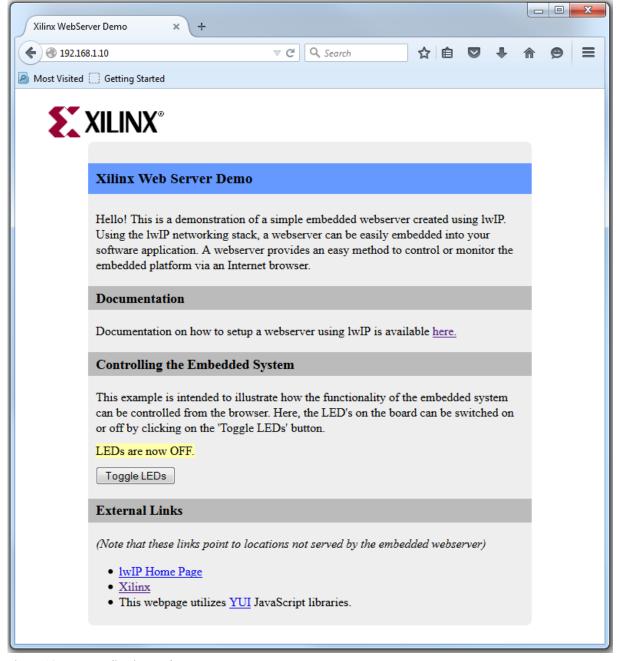


Figure 12: LwIP Application Web Page

Testing the LwIP Telnet Echo Server

Step	Description
1	Open a Telnet program (e.g. PuTTY) and configure the following parameters (see Figure 13):
	 For Host Name type 192.168.1.10 For Protocol select Telnet For Port type 7 Click Open
2	Each character sent to the Mars ZX3 SoC module is immediately sent back (each character appears twice in the Telnet terminal).

Table 12: Testing the LwIP Telnet Echo Server Step-By-Step Guide

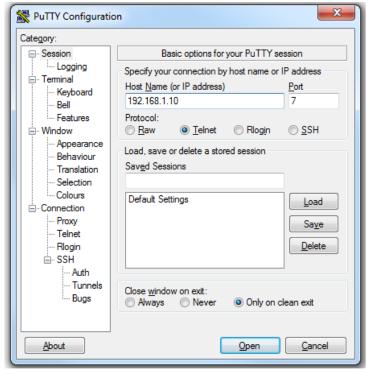


Figure 13: PuTTY Configuration for Telnet Communication

Figure 14 displays the UART output of the Ethernet lwIP application, corresponding to web page loading action and to Telnet echo calls.

```
--lиIP RAH Mode Demo Application -----
Board IP:
                 192.168.1.10
                 255.255.255.0
Netmask:
                 192.168.1.1
Gateuau :
Add network
Set PHY Delays on Addr 3
auto-negotiated link speed: 1000 Hbit
netif set default
               Server
                        Port Connect Hith..
                            7 $ telnet <board_ip> 7
          echo server
                           80 Point your web Browser to http://192.168.1.10
         http server
http GET: index.html
http GET: css/main.css
http GET: images/logo.gif
http GET: yui/yahoo.js
http GET: yui/doн.js
http GET: yui/event.js
http GET: yui/conn.js
http GET: yui/aniн.js
http GET: js/наin.js
echo_accept_callback
echo_recv_callback
echo_recv_callback
echo_recv_callback
echo recv callback
echo_recv_callback
echo_recv_callback
echo_recv_callback
echo_recv_callback
echo_recv_callback
```

Figure 14: Ethernet LwIP Application UART Output

3.7.7 USB Storage Application

The USB storage application represents a basic example of a USB storage emulation.

The example is based on the Xilinx USB example (xusbps_intr_example.c), including additional printing messages.

In order to run the USB storage emulation example, two USB cables are required: one for the UART output (micro USB) and one for the USB storage emulation (USB type B).

While running the application, the USB type B cable needs to be connected to the base board. After connecting the cable, Windows will issue a message asking the user to format the disk (see Figure 15).



Figure 15: Windows Message after Connecting a USB Cable

After formatting the disk (capacity 1 MB, FAT), a USB storage is visible and usable as a standard removable disk in Windows.

In order to run the USB example, the following steps are required:

Step	Description
1	Set the configuration DIP switches on the Mars PM3 base board as follows (see labels CFG A and CFG B in Figure 2):
	 CFG A = [1: ON, 2: OFF, 3: ON, 4: OFF] CFG B = [1: ON, 2: OFF, 3: OFF, 4: OFF]
	For Mars PM3 base board revision 4 or older, set the configuration DIP switches as follows:
	• CFG = [1: OFF, 2: OFF, 3: ON, 4: OFF]
2	For UART output, connect a USB cable between your computer and the Mars PM3 base board. Use the micro USB port labeled USBUB in Figure 2.
3	Start the application as described in Section 3.6
4	For the USB storage, connect a USB cable between your computer and the Mars PM3 base board. Use the USB type B port labeled USB in Figure 2.
5	Format the disk and use it as standard removable disk storage.

Table 13: Running the USB Storage Example Step-By-Step Guide

Figure 16 shows the UART output of the USB storage application.

```
== Enclustra USB Test ==
Connect a USB cable to the USB connector
Hindous will ask you to format the disk
```

Figure 16: USB Storage Application UART Output

3.7.8 First Stage Boot Loader (FSBL) Application

The First Stage Boot Loader application is used in the boot image creation process described in Section 4.1.1. It is not used as an independent application.

The FSBL application is based on the Xilinx FSBL, extended by functions that enable the RGMII delays in the Ethernet PHY and initialize the real-time clock (RTC).

In addition, the FSBL reads the Ethernet MAC address via I2C from the secure EEPROM and configures the Ethernet MAC accordingly. If the secure EEPROM cannot be accessed, a default MAC address is assigned to the MAC.

The changes mentioned above are done in fsbl_hooks.c file.

The source files provided in the ZIP archive along with this document must be copied into the software workspace, after generating the FSBL using Xilinx tools. Section 3.4 describes the required steps for FSBL project generation.

4 Boot Configurations

Once a software application has been developed and tested, this can be used to build a boot image for the module.

The boot image contains the FSBL, the bitstream for programming the PL, and the software bare-metal application.

In order to use a software application for the boot image, the code must be mapped for execution from the external DDR memory. If the program is mapped to the on-chip memory, it will overwrite the boot loader during execution.

For a fast test of the boot configurations, the pre-generated .bin images included in the <base_dir>\binaries directory may be used for boot, instead of rebuilding the image. You need to select the file corresponding to the SoC device that is equipped on the module.

4.1 QSPI Flash Boot

4.1.1 Generating the Image Files

Step	Description
1	Create the boot image from Xilinx SDK 2015.2 (see Figure 17):
	1. Right click on the application in the Project Explorer 2. Select Create Boot Image $ ightarrow$ Create Image
2	For the lwIP Application, the following extra steps are required (see Figure 18):
	In Create Zynq Boot Image Window hit Add
	 In File path field type the path to the memory file system image from the lwIP example: <base_dir>\software\lwip_example\image.mfs</base_dir> In Load field type 0x8000000 Hit OK
3	In Create Zynq Boot Image Window hit Create Image.
	An image will be created in <workspace>\<app_name>\bootimage\BOOT.bin.</app_name></workspace>

Table 14: Generating the Image Files for QSPI Flash Boot Mode Step-by-Step Guide

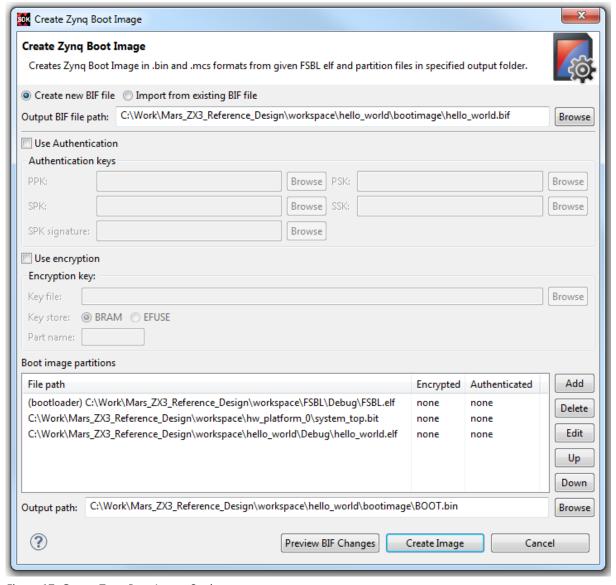


Figure 17: Create Zynq Boot Image Settings

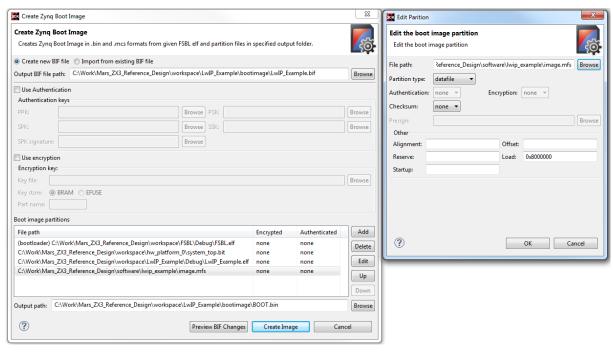


Figure 18: Create Zynq Boot Image Settings for LwIP Application

4.1.2 Preparing the Hardware

Step	Description
1	Remove the power supply from the Mars PM3 base board (see label 12 V DC in Figure 2).
2	Set the configuration DIP switches on the Mars PM3 base board as follows (see labels CFG A and CFG B in Figure 2):
	 CFG A = [1: ON, 2: OFF, 3: OFF, 4: OFF] CFG B = [1: OFF, 2: OFF, 3: OFF, 4: OFF]
	For Mars PM3 base board revision 4 or older, enable the QSPI flash boot mode by removing the jumper between pins 5 and 6 of J801 of Mars PM3 base board or the FPGA MODE jumper located on the JTAG breakout board (see label FPGA MODE in Figure 2).
3	Connect the 12 V DC power supply plug to the power connector of the Mars PM3 base board (see label 12 V DC in Figure 2).

Table 15: Preparing the Hardware for QSPI Flash Boot Mode Step-by-Step Guide

4.1.3 Programming the QSPI Flash

Step	Description
1	Open Xilinx SDK 2015.2:
	 Xilinx Tools → Program Flash In Program Flash Memory window (see Figure 19): (a) For Image File select the boot image generated as described in Section 4.1.1 (b) For Flash Type select qspi_single (c) Hit Program and wait for completion
2*	Optional - if SDK returns errors during flash programming or if the system does not boot properly, another option is to use Vivado 2015.2 to program the QSPI flash.
	 Flow → Open Hardware Manager Click on Open target → Auto Connect Right click on the corresponding FPGA device in the left bar → Add Configuration Memory Device (see Figure 20)
	 (a) For Select Configuration Memory Part choose the memory part according to the Mars ZX3 SoC Module User Manual [5], part type single. This is in most cases s25fl512s-qspi-x4-single. (b) Hit OK
	4. In Program Configuration Memory Device window (see Figure 21):
	(a) For Configuration file select the boot image generated as described in Section 4.1.1(b) In Program Operations section:
	 For Address Range select Entire Configuration Memory Device Enable checkboxes Erase, Blank Check, Program and Verify Hit OK and wait for completion
	The settings in the pictures are for reference only. Note that the memory part and the configuration file must be selected according to your application.
3*	Optional - alternatively, Enclustra Module Configuration Tool (MCT) [7] can be used to program the QSPI flash.
	Before programming the QSPI flash from MCT, make sure the hardware configuration on the Mars PM3 base board is done according to Section 4.1.2.
	Use USB 3.0 type B port (see label USB in Figure 2) to program the QSPI flash using MCT.

Table 16: Programming the QSPI Flash for QSPI Flash Boot Mode Step-by-Step Guide

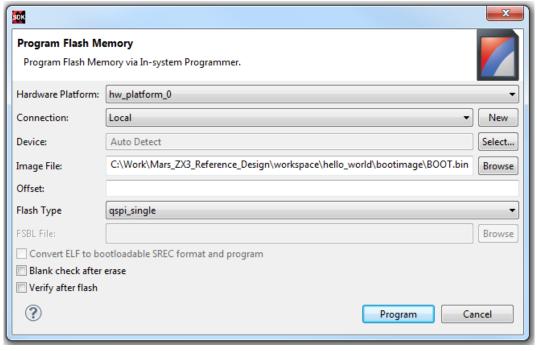


Figure 19: QSPI Flash Programming Settings in SDK

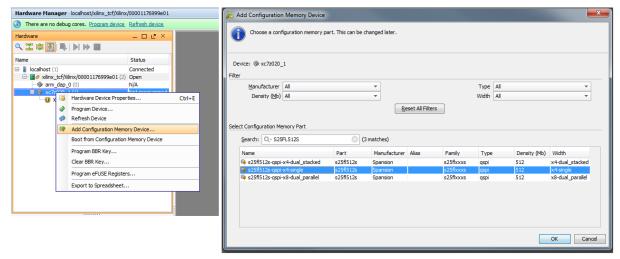


Figure 20: QSPI Flash Programming Settings in Vivado - Adding the Memory Device

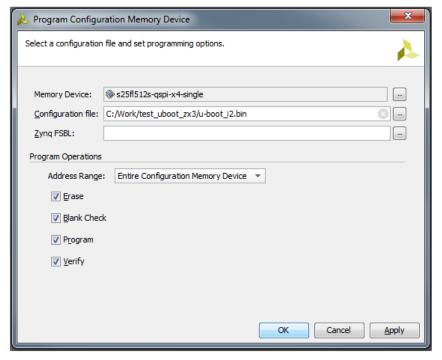


Figure 21: QSPI Flash Programming Settings in Vivado

4.1.4 Booting from the QSPI Flash

Step	Description
1	Check that the hardware configuration is done according to Section 4.1.2.
2	Press the power-on reset button (see label POR in Figure 2) and release it after a second.
	For Mars PM3 base board revision 4 or older, press the power-on reset button labeled LD.

Table 17: Booting from the QSPI Flash Step-by-Step Guide

4.2 SD Card Boot

4.2.1 Generating the Image Files

Please refer to Section 4.1.1 describing the steps required to generate a boot image.

4.2.2 Preparing the Hardware

Step	Description
1	Remove the power supply from the Mars PM3 base board (see label 12 V DC in Figure 2).
2	Set the configuration DIP switches on the Mars PM3 base board as follows (see labels CFG A and CFG B in Figure 2):
	 CFG A = [1: ON, 2: OFF, 3: OFF, 4: OFF] CFG B = [1: ON, 2: OFF, 3: OFF, 4: OFF]
	For Mars PM3 base board revision 4 or older, enable the SD card boot mode by mounting a jumper between pins 5 and 6 of J801 of Mars PM3 base board or the FPGA MODE jumper located on the JTAG breakout board (see label FPGA MODE in Figure 2).

Table 18: Preparing the Hardware for SD Card Boot Mode Step-by-Step Guide

4.2.3 Programming the SD Card

Step	Description
1	Write the Xilinx SD card boot image to the SD card
	 Insert the SD card into the SD card slot of your computer Copy the boot image generated for your application from <workspace>\<app_name>\bootimage\BOOT.bin to your SD card (directly in the root directory).</app_name></workspace> Note that the name of the image must be preserved.

Table 19: Programming the SD Card for SD Card Boot Mode Step-by-Step Guide

4.2.4 Booting from the SD Card

Step	Description
1	Remove the power supply from the Mars PM3 base board (see label 12 V DC in Figure 2).
2	Insert the SD card into the SD card slot of the Mars PM3 base board (see label SD Card in Figure 2).
3	Reconnect the power supply to the Mars PM3 base board (see label 12 V DC in Figure 2).

Table 20: Booting from the SD Card Step-by-Step Guide

5 Troubleshooting

5.1 Vivado Issues

- If the changes in the block design (including licenses for special IPs) are not propagated into implementation, open the Hierarchy tab in Vivado and regenerate the block design files:
 - 1. Right click on the block design file (.bd)
 - 2. Click on Reset Output Products \rightarrow Reset
 - 3. Click on Generate Output Products \rightarrow Generate \rightarrow OK

5.2 SDK Runtime Exceptions

- In order to avoid runtime exceptions issued by SDK, always stop running processes with the red Terminate button. In debug mode, hit this button before resetting or disconnecting the Mars ZX3 SoC module.
- If the SDK reports runtime exceptions while downloading a program to memory, the following steps should be followed:
 - 1. Close SDK
 - 2. Shutdown any javaw, eclipse or xmd processes in Windows Task Manager
 - 3. Power off the Mars ZX3 SoC module
 - 4. Restart SDK and power on the Mars ZX3 SoC module
- After using SD card or flash boot on Zynq, the debugger will not connect to the target device anymore. In order to re-enable the debugger connection, the following steps should be followed:
 - 1. Remove the SD card and select the SD card boot mode, or alternatively, delete the QSPI flash and select the flash boot mode
 - 2. Restart the Mars ZX3 SoC module

5.3 JTAG Connection Issues

- If the JTAG cable is not detected, the following steps should be followed:
 - 1. Make sure that the hardware configuration is made according to Section 3.2
 - 2. Remove the USB connection and power supply from the Mars PM3 base board and close SDK
 - 3. Reconnect the USB and power supply and start SDK again
 - 4. Reboot the computer if the problem persists

5.4 UART Connection Issues

- If the computer is not able to recognize the USB UART on the Mars PM3 base board:
 - 1. Check that the USB cable is connected properly
 - 2. Check that the FTDI VCP drivers are installed
 - (a) Open Device Manager
 - (b) Universal Serial Bus controllers \rightarrow USB Serial Converter A/B \rightarrow Properties \rightarrow Advanced tab \rightarrow enable Load VCP checkbox
 - (c) Reboot the computer if the COM port is still not detected
 - 3. Reinstall the FTDI drivers if the problem persists
- If the computer does not output any character in the terminal program:
 - 1. Check that the FTDI device is set to UART mode:
 - (a) Download and open FT_Prog utility (this is a third party tool offered by the FTDI company to configure FTDI devices)
 - (b) DEVICES → Scan and Parse

- (c) Check that for Port A and B the RS232 UART property is true
- 2. Check that the baud rate for the UART in the block design matches the baud rate set in the terminal program
- 3. If the UART used is mapped to the EMIO pins in the PS, resetting the ARM core will not suffice. Reprogramming the PL is necessary, as the UART lines go through PL.

5.5 **QSPI Boot Issues**

- If the Mars ZX3 SoC module is not able to boot from the QSPI flash:
 - 1. Use Vivado to program the flash
 - (a) Make sure that the Memory Device part type is correctly selected
 - (b) Make sure Erase and Program options are enabled
 - (c) Select Entire Configuration Memory Device for Address Range
 - 2. If the problem persists, a possible solution is to first erase the flash, and then program it either from Vivado or SDK

Please refer to Section 4.1.3 for details on QSPI flash programming.

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- [5] Mars ZX3 SoC Module User Manual

http://download.enclustra.com/#Mars_ZX3

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